

TC7MBL3245SFT, TC7MBL3245SFK

Low Voltage/Low Capacitance Octal Bus Switch

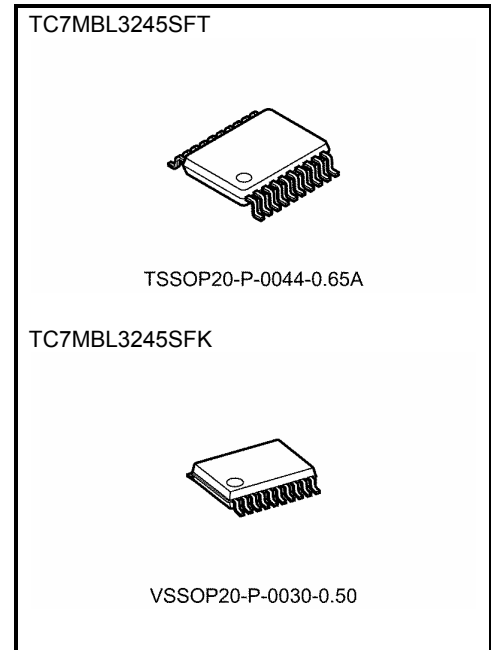
The TC7MBL3245S provides eight bits of low-voltage, high-speed bus switching in a standard '245 device pinout. The low ON-resistance of the switch allows connections to be made with minimal propagation delay and while maintaining CMOS low power dissipation.

The device comprises a single 8-bit switch. When output enable (\overline{OE}) is low, the switch is on and port A is connected to port B. When \overline{OE} is high, the switch is open and a high-impedance state exists between the two ports.

All inputs are equipped with protection circuits to guard against static discharge.

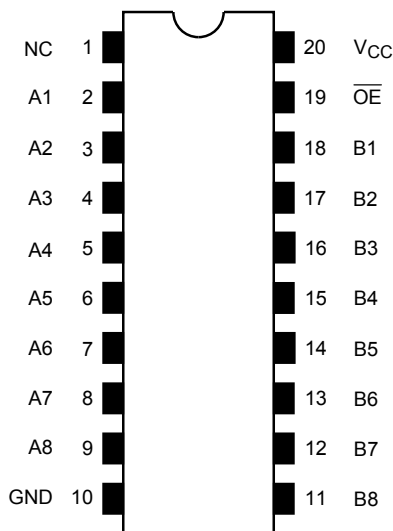
Features

- Operating voltage: $V_{CC} = 1.65$ to 3.6 V
- Low capacitance: $C_{I/O} = 12$ pF Switch On (typ.) @3 V
- Low on resistance: $R_{ON} = 9 \Omega$ (typ.) @3 V
- ESD performance: Machine model $\geq \pm 200$ V
Human body model $\geq \pm 2000$ V
- Power down protection for inputs (\overline{OE} input only)
- Package: TSSOP20, VSSOP (US20)
- Pin compatible with the 74xx245 type



| | |
|----------------------|-----------------|
| Weight | |
| TSSOP20-P-0044-0.65A | : 0.08 g (typ.) |
| VSSOP20-P-0030-0.50 | : 0.03 g (typ.) |

Pin Assignment (top view)

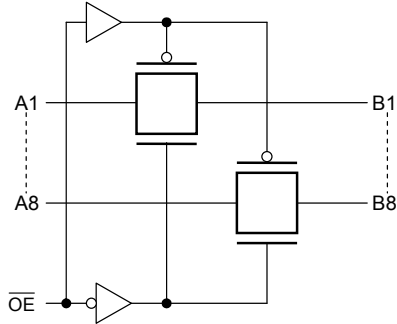


NC-No Internal Connection

Truth Table

| Inputs | Function |
|-----------------|-----------------|
| \overline{OE} | |
| L | A port = B port |
| H | Disconnect |

System Diagram



Absolute Maximum Ratings (Note)

| Characteristic | | Symbol | Rating | Unit |
|-----------------------------|-------------------|------------------|------------------------|-------------|
| Power supply range | | V_{CC} | -0.5 to 4.6 | V |
| Control pin input voltage | | V_{IN} | -0.5 to 4.6 | V |
| Switch terminal I/O voltage | | V_S | -0.5 to $V_{CC} + 0.5$ | V |
| Clump diode current | Control input pin | I_{IK} | -50 | mA |
| | Switch terminal | | ± 50 | mA |
| Switch I/O current | | I_S | 50 | mA |
| Power dissipation | | P_D | 180 | mW |
| DC V_{CC}/GND current | | I_{CC}/I_{GND} | ± 100 | mA |
| Storage temperature | | T_{stg} | -65 to 150 | $^{\circ}C$ |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

| Characteristic | Symbol | Rating | Unit |
|---------------------------|-----------|---------------|-------------|
| Power supply voltage | V_{CC} | 1.65 to 3.6 | V |
| Control pin input voltage | V_{IN} | 0 to 3.6 | V |
| Switch I/O voltage | V_S | 0 to V_{CC} | V |
| Operating temperature | T_{opr} | -40 to 85 | $^{\circ}C$ |
| Input rise and fall time | dt/dv | 0 to 10 | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

| Parameter | Symbol | Test Condition | V _{CC} (V) | Min | Typ. | Max | Unit | |
|--|------------------|---|---------------------|-------------|-----------------------|-----|-----------------------|----|
| | | | | | | | | |
| Input voltage | "H" level | V _{IH} | — | 1.65 to 3.6 | 0.7 × V _{CC} | — | — | V |
| | "L" level | V _{IL} | — | 1.65 to 3.6 | — | — | 0.3 × V _{CC} | |
| Input leakage current | I _{IN} | V _{IN} = 0 to 3.6V | | 1.65 to 3.6 | — | — | ±1.0 | μA |
| Power off leakage current | I _{OFF} | \overline{OE} = 0 to 3.6 V | | 0 | — | — | 1.0 | μA |
| Off-state leakage current (switch off) | I _{SZ} | A, B = 0 to V _{CC} , \overline{OE} = V _{CC} | | 1.65 to 3.6 | — | — | ±1.0 | μA |
| On resistance (Note2) | R _{ON} | V _{IS} = 0 V, I _{IS} = 30 mA (Note1) | | 3.0 | — | 9 | 13 | Ω |
| | | V _{IS} = 3.0 V, I _{IS} = 30 mA (Note1) | | 3.0 | — | 15 | 20 | |
| | | V _{IS} = 2.4 V, I _{IS} = 15 mA (Note1) | | 3.0 | — | 19 | 27 | |
| | | V _{IS} = 0 V, I _{IS} = 24 mA (Note1) | | 2.3 | — | 10 | 16 | |
| | | V _{IS} = 2.3 V, I _{IS} = 24 mA (Note1) | | 2.3 | — | 17 | 24 | |
| | | V _{IS} = 2.0 V, I _{IS} = 15 mA (Note1) | | 2.3 | — | 21 | 30 | |
| Increase in I _{CC} per input | I _{CC} | V _{IN} = V _{CC} or GND, I _{OUT} = 0 | | 3.6 | — | — | 10 | μA |

Note1: All typical values are at Ta=25°C.

Note2: Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

AC Characteristics (Ta = -40 to 85°C)

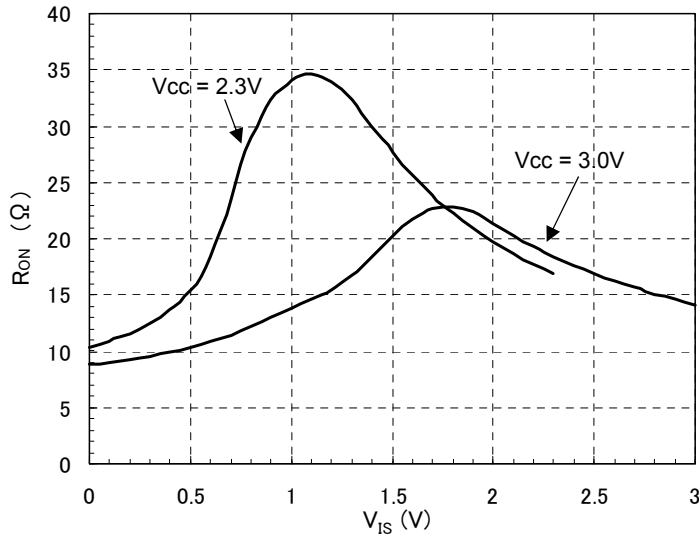
| Characteristics | Symbol | Test Condition | V _{CC} (V) | Min | Max | Unit |
|---------------------|--------------------------------------|--------------------|---------------------|-----|-----|------|
| | | | | | | |
| Output enable time | t _{pZL} t _{pZH} | Figure 1, Figure 2 | 3.3 ± 0.3 | — | 6 | ns |
| | | | 2.5 ± 0.2 | — | 7 | |
| | | | 1.8 ± 0.15 | — | 11 | |
| Output disable time | t _{pLZ} t _{pHZ} | Figure 1, Figure 2 | 3.3 ± 0.3 | — | 6 | ns |
| | | | 2.5 ± 0.2 | — | 7 | |
| | | | 1.8 ± 0.15 | — | 11 | |

Capacitive Characteristics (Ta = 25°C)

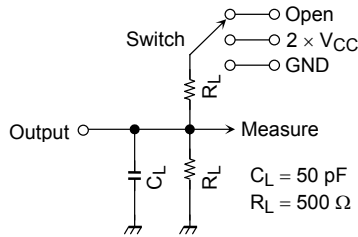
| Characteristics (Note) | Symbol | Test Condition | V _{CC} (V) | Typ. | Unit |
|-------------------------------|------------------|--|---------------------|------|------|
| | | | | | |
| Control pin input capacitance | C _{IN} | | 3.0 | 3 | pF |
| Switch terminal capacitance | C _{I/O} | \overline{OE} = V _{CC} (switch off) | 3.0 | 6 | pF |
| | | \overline{OE} = GND (switch on) | 3.0 | 12 | pF |

Note : This parameter is guaranteed by design

RON Characteristic (typ.) Ta=25°C



AC Test Circuit



| Parameter | Switch |
|--------------------|-------------------|
| t_{pLH}, t_{pHL} | Open |
| t_{pLZ}, t_{pZL} | $2 \times V_{CC}$ |
| t_{pHZ}, t_{pZH} | GND |

Figure 1

AC Waveform

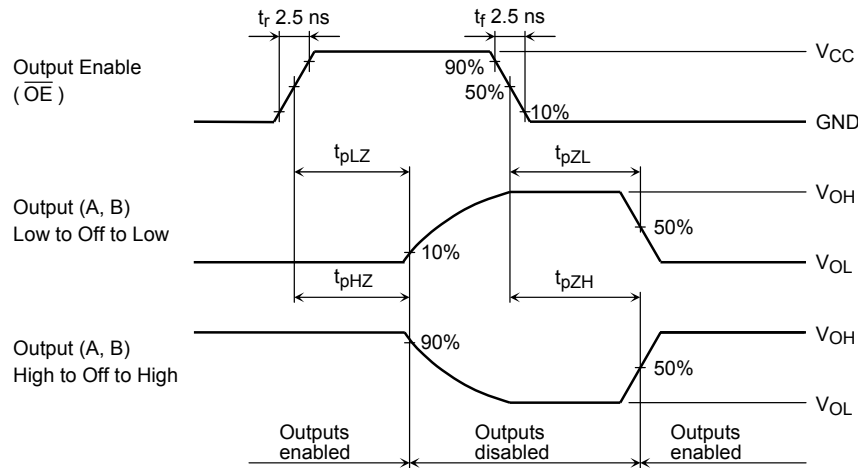


Figure 2 $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$

Rise and Fall Times (tr / tf) of the TC7MBL3245S I/O Signals

The tr(out) and tf(out) values of the output signals are affected by the CR time constant of the input, which consists of the switch terminal capacitance (C_{I/O}) and the on-resistance (R_{ON}) of the input.

In practice, the tr(out) and tf(out) values are also affected by the circuit's capacitance and resistance components other than those of the TC7MBL3245S.

The tr / tf (out) values can be approximated as follows. (Figure 4 shows the test circuit.)

$$tr / tf \text{ out (approx)} = - (C_{I/O} + C_L) \cdot (R_{DRIVE} + R_{ON}) \cdot \ln (((V_{OH} - V_{OL}) - V_M) / (V_{OH} - V_{OL}))$$

where, R_{DRIVE} is the output impedance of the previous-stage circuit.

Calculation example:

$$tr \text{ out (approx)} = - (12 + 15) \cdot 10^{-12} \cdot (120 + 9) \cdot \ln (((3.0 - 0) - 1.5) / (3.0 - 0))$$

$$\approx 2.4 \text{ ns}$$

Calculation conditions:

V_{CC} = 3.0V , C_L = 15pF , R_{DRIVE} = 120Ω(output impedance of the previous IC), V_M = 1.5V(V_{CC} / 2)
 Output of the previous IC = digital (i.e., high-level voltage = V_{CC}; low-level voltage = GND)

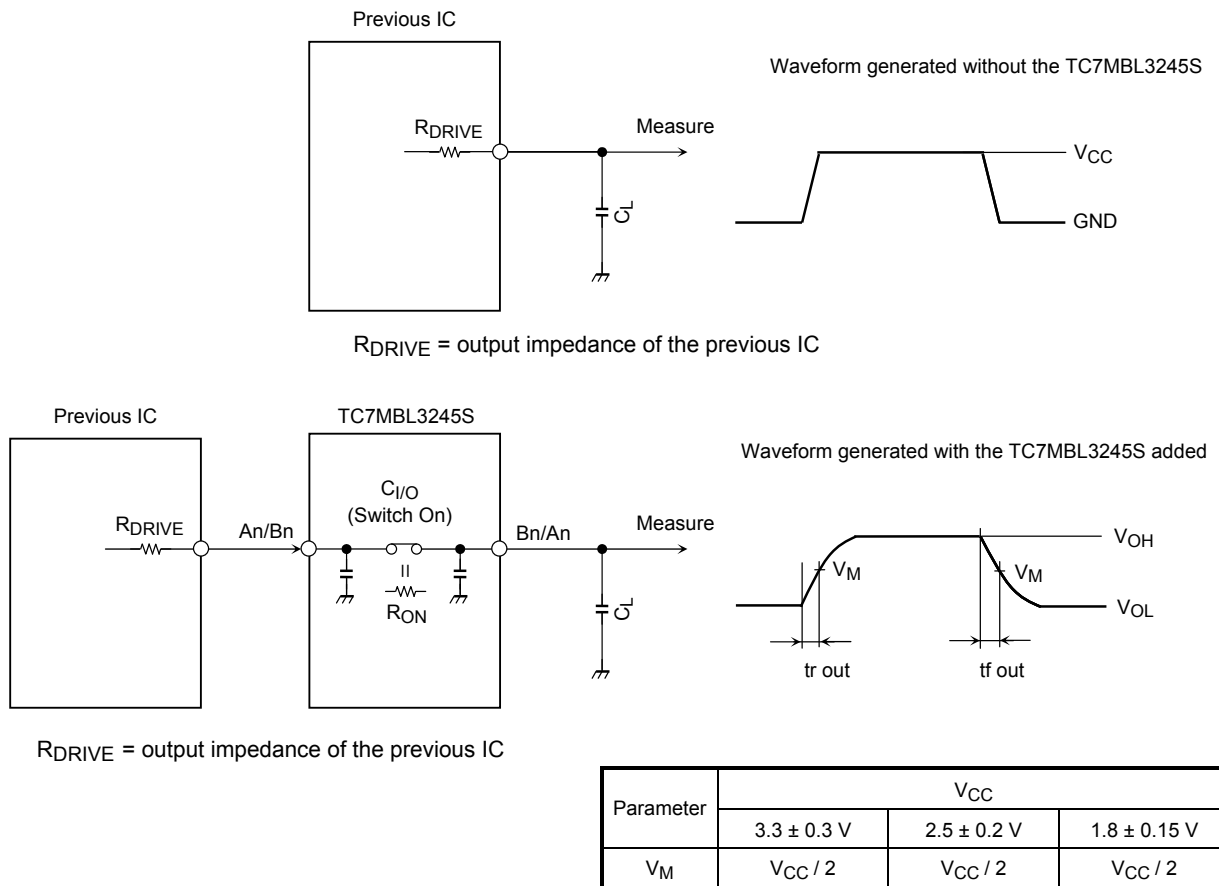
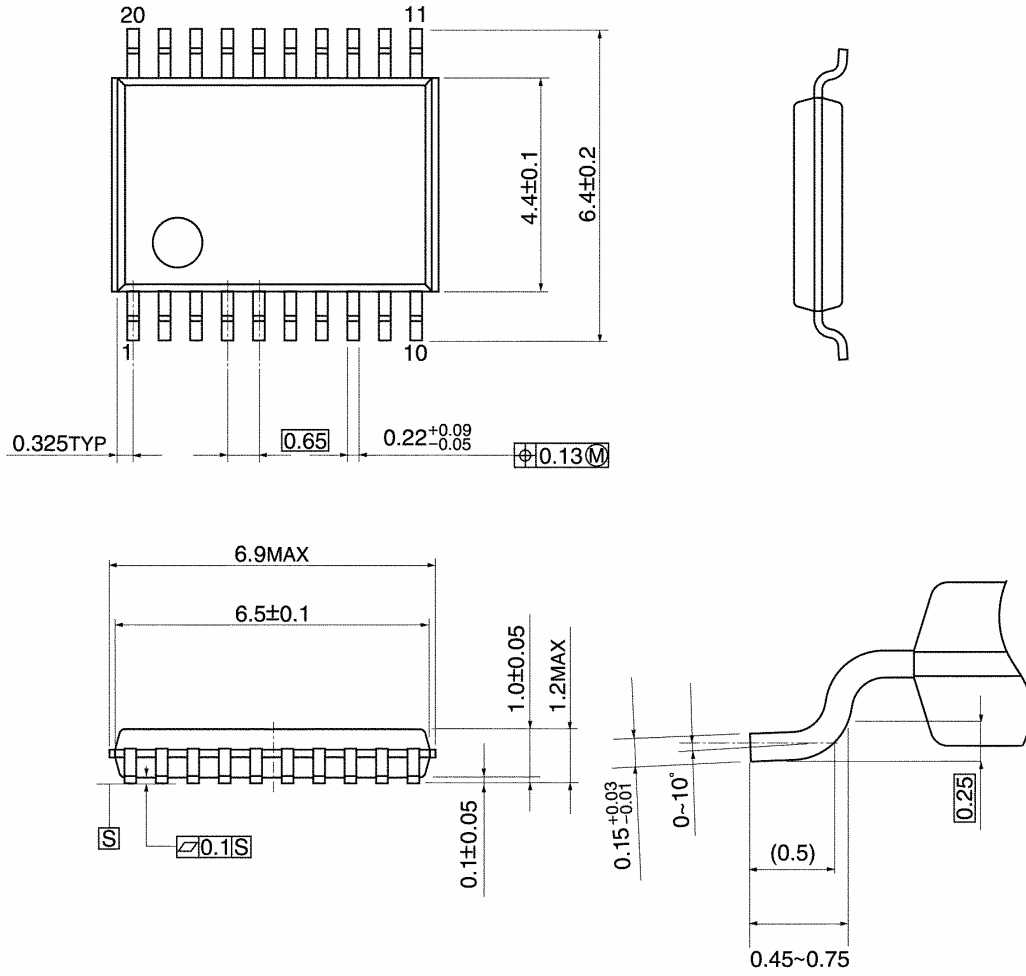


Figure 3 Test Circuit

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

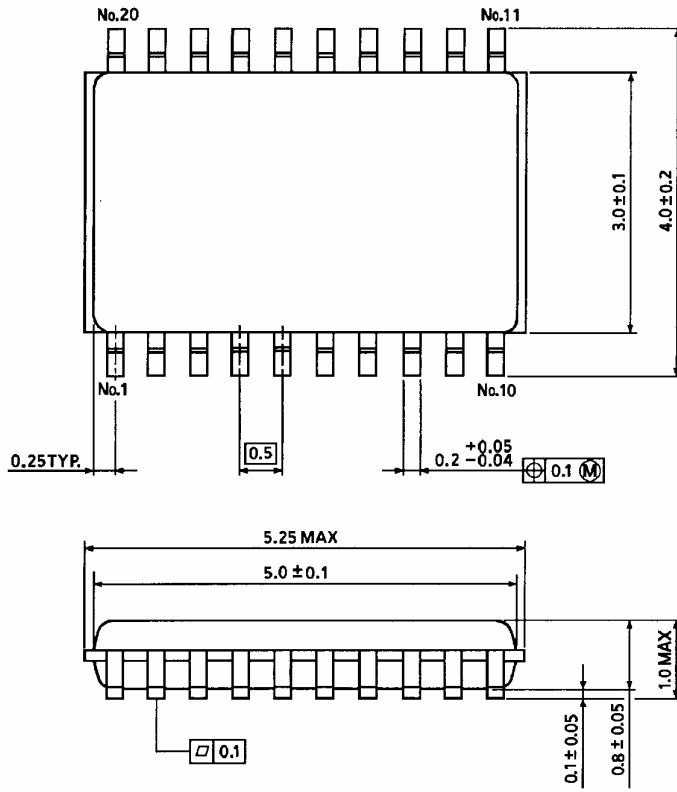


Weight: 0.08g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit : mm



Weight: 0.03g (typ.)

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20070701-EN

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